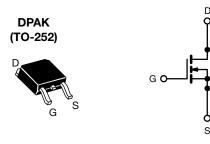
**Vishay Siliconix** 



## **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.6			
Q <sub>g</sub> max. (nC)	48				
Q <sub>gs</sub> (nC)	6				
Q <sub>gd</sub> (nC)	11				
Configuration	Single				



N-Channel MOSFET

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	DPAK (TO-252)			
	SiHD6N65E-GE3			
Lood (Db) free and Lielenen free	SiHD6N65ET1-GE3			
Lead (Pb)-free and Halogen-free	SiHD6N65ET4-GE3			
	SiHD6N65ET5-GE3			

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	V	
Gate-Source Voltage			V <sub>GS</sub>	± 30	V	
Continuous Drain Current (T. 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	7		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		5	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	18		
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	56	mJ	
Maximum Power Dissipation			PD	78	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		-l\//-lt	37		
Reverse Diode dV/dt <sup>d</sup>			dV/dt	27	V/ns	
Coldering Recommendations (Peak Temperature) c for 10 s			300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,~I_{AS}$  = 2 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,\,dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	_		62 1.6				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-				°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	unless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	<b>CONDIT</b>	IONS	MIN.	TYP.	MAX.	UNI
Static	1				•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 µA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°0
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2	-	4	V
Osta Course Laskans			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zara Cata Valtaga Drain Current		V <sub>DS</sub> =	= 650 V, V <sub>G</sub>	<sub>iS</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 \	/, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$		I <sub>D</sub> = 3 A	-	0.5	0.6	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 3 A	-	2	-	S
Dynamic	•				-	•	•	•
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	820	-	pF	
Output Capacitance	C <sub>oss</sub>			-	40	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 520 V, $V_{GS} = 0$ V		-	36	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	117	-		
Total Gate Charge	Qg		V <sub>GS</sub> = 10 V I <sub>D</sub> = 3 A, V <sub>DS</sub> = 520 V		-	24	48	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$			-	6	-	
Gate-Drain Charge	Q <sub>gd</sub>				-	11	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	14	28	
Rise Time	t <sub>r</sub>	Vaa	$V_{DD}$ = 520 V, I <sub>D</sub> = 3 A, V <sub>GS</sub> = 10 V, R <sub>a</sub> = 9.1 Ω		-	12	24	ns
Turn-Off Delay Time	t <sub>d(off)</sub>				-	30	60	
Fall Time	t <sub>f</sub>			-	20	40	1	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	1.4	-	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	_	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	18	A	
Diode Forward Voltage	V <sub>SD</sub>	$T_{\rm J} = 25 ^{\circ}\text{C},  I_{\rm S} = 3 \text{A},  V_{\rm GS} = 0 \text{V}$		-	-	1.3	V	
Reverse Recovery Time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 3 \text{ A},$ $dI/dt = 100 \text{ A}/\mu \text{s}, V_{R} = 25 \text{ V}$		-	237	-	ns	
Reverse Recovery Charge	Q <sub>rr</sub>			-	2.2	-	μ	
Reverse Recovery Current	I <sub>RRM</sub>			L			P. C	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

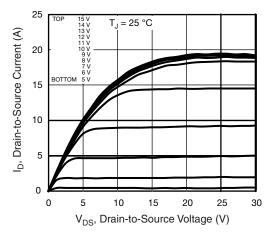


Fig. 1 - Typical Output Characteristics

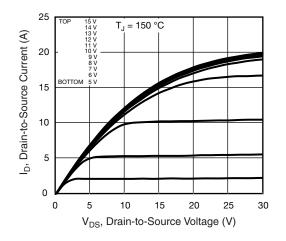


Fig. 2 - Typical Output Characteristics

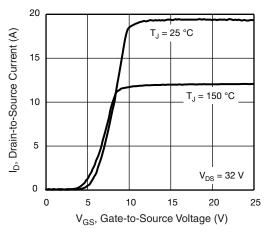


Fig. 3 - Typical Transfer Characteristics

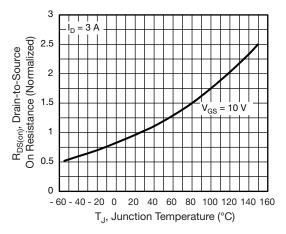


Fig. 4 - Normalized On-Resistance vs. Temperature

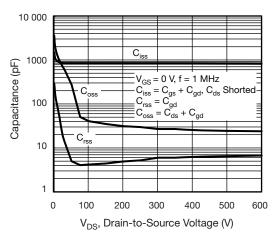


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

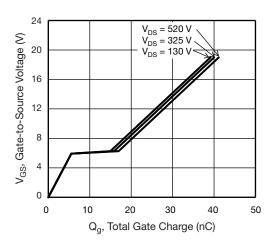


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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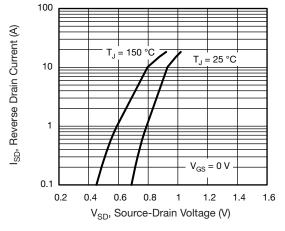


Fig. 7 - Typical Source-Drain Diode Forward Voltage

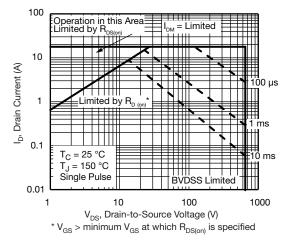


Fig. 8 - Maximum Safe Operating Area

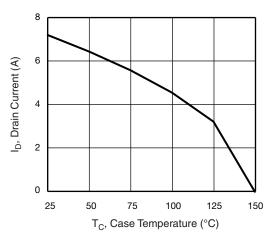


Fig. 9 - Maximum Drain Current vs. Case Temperature

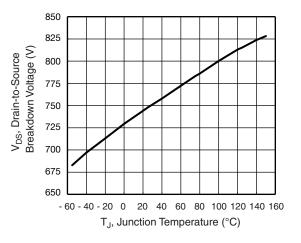
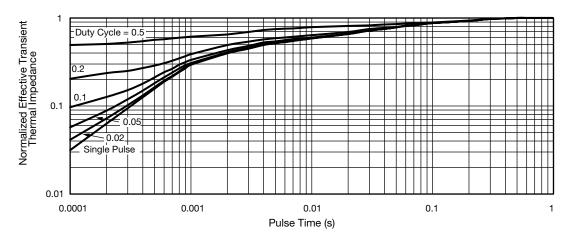
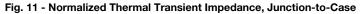


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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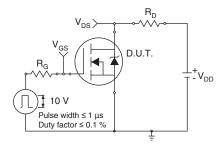


Fig. 12 - Switching Time Test Circuit

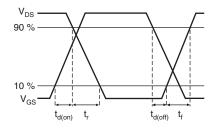


Fig. 13 - Switching Time Waveforms

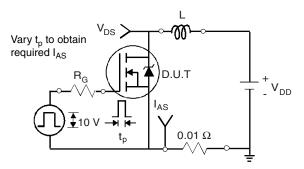


Fig. 14 - Unclamped Inductive Test Circuit

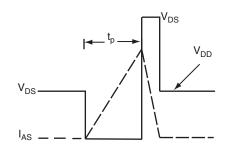


Fig. 15 - Unclamped Inductive Waveforms

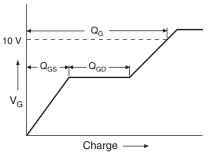


Fig. 16 - Basic Gate Charge Waveform

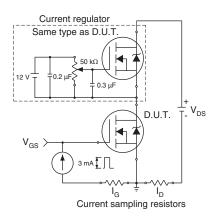


Fig. 17 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

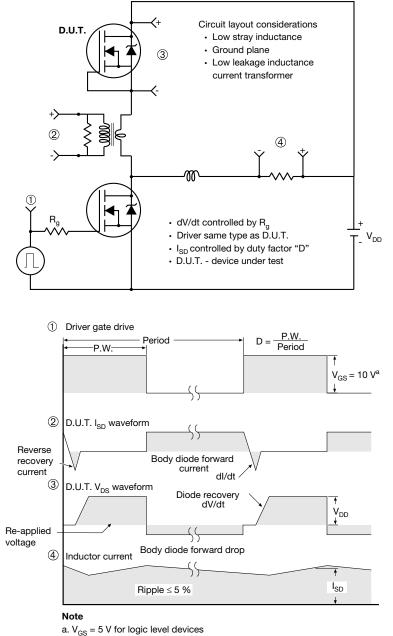
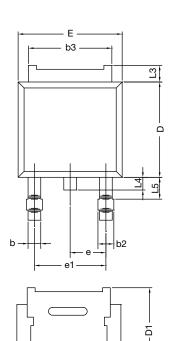


Fig. 18 - For N-Channel

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E1

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**TO-252AA** Case Outline

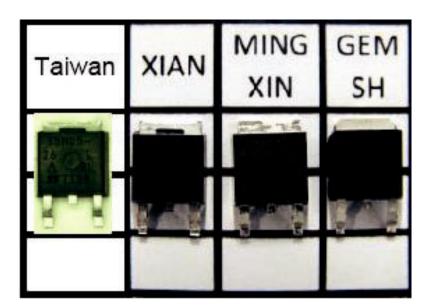
	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0359-Rev. O, 03-Jun-13 DWG: 5347					

#### .....

Notes

• Dimension L3 is for reference only.

• Xi'an, Mingxin, and GEM SH actual photo.



Revision: 03-Jun-13

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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